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Enhanced mechanical quality factor of BiScO₃–PbTiO₃ piezoelectric ceramics using glass composition

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Compared with pure Pb-based perovskite ferroelectric materials, Bi(Me)O₃–PbTiO₃ (Me = Sc³⁺, In³⁺, Yb³⁺) have attracted attention due to their remarkable advantage in their Curie temperature. Among them, BiScO₃–PbTiO₃ piezoelectric ceramic is a potential piezoelectric material in high-temperature applications for its high Curie temperature and excellent piezoelectric coefficient. However, its shortcomings are high dielectric loss and low mechanical quality factor. Herein, we report the improvement of the mechanical quality factor of 0.36BS–0.64PT ceramics through the addition of glass composition (GeO₂). There is a small change in the Curie temperature after GeO₂ addition. The piezoelectric coefficient d_{33} and planar electromechanical coupling factor k_p increase first and then decrease, and the mechanical quality factor Q_m monotone increases with an increase in GeO₂. The 0.36BS–0.64PT + 0.5 mol%GeO₂ ceramics have optimal electrical properties with T_C of 455 °C, d_{33} of 385 pC N⁻¹, k_p of 58%, and Q_m of 90. In addition, the thermal stability of 0.36BS–0.64PT + xGeO₂ and 0.36BS–0.64PT ceramics is almost the same. It was concluded that the mechanical quality factor of BS–PT ceramics can be enhanced by the addition of GeO₂ with other properties remaining unchanged.

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1. Introduction

With the requirement of high-temperature piezoelectric sensors and actuators in aerospace, automobiles, oil and gas exploration fields, high-temperature piezoelectric materials have received unprecedented attention.^{1–4} The use temperature of piezoelectric materials is about half of the Curie temperature (T_C) due to piezoelectric performance degradation at high temperatures.⁵ The commercial lead–zirconium–titanium (PZT) piezoelectric ceramics have been studied for decades and are widely used in piezoelectric sensors and transducers, but these ceramics cannot be used in environments above 200 °C, while applications in the aerospace and automotive industries require piezoelectric devices to operate at a temperatures of 300 °C or higher.^{6,7} Therefore, the development of new high-temperature-stable piezoelectric materials is an extremely urgent need.

Bismuth-based perovskite solid solutions with the formula of Bi(Me)O₃–PbTiO₃ (Me = Sc, In, Yb, Mg/Ti, Fe, Ga *et al.*), which are potential alternatives for high-temperature application, have attracted growing interest due to their ultra-high Curie temperature.^{8–13} Among them, BiYbO₃–PbTiO₃, BiInO₃–PbTiO₃, Bi(Mg_{1/2}Ti_{1/2})O₃–PbTiO₃ and BiFeO₃–PbTiO₃ are not suitable for

applications due to their poor piezoelectric properties. BiScO₃–PbTiO₃ (BS–PT) solid solutions have drawn considerable attention because of their high piezoelectric constant (d_{33}) of 460 pC N⁻¹ and high T_C of 450 °C near the morphotropic phase boundary (MPB).^{14,15} In addition, due to the advantages of high working efficiency, good flexibility, high strength and toughness of flexible ceramic film materials, some researchers have focused on preparing multifunctional materials on flexible substrates. For example, Liu successfully fabricated Mn–In₂O₃ thin films with excellent mechanical durability and transparent conductive oxide SrVO₃ thin films by pulsed laser deposition (PLD) on flexible substrates.^{16,17} BS–PT solid solutions have small crystal anisotropy and excellent electrical performance, which can be combined with a flexible substrate to improve the piezoelectric response.¹⁸

The shortcomings of BS–PT ceramics are high dielectric loss ($\tan \delta > 3\%$) and a low mechanical quality factor ($Q_m < 30$),^{19,20} which limit their application at high temperatures. Previously, a great deal of work has been done to increase the Q_m of BS–PT ceramics through chemical methods, such as the addition of Mn, Fe, Pb(Mn_{1/3}Nb_{2/3})O₃, Pb(Mn_{1/3}Sb_{2/3})O₃.^{4,21–25} The mechanical quality factor can be enhanced by chemical methods, while the piezoelectric performance and Curie temperature are often decreased. For example, the piezoelectric performance of (0.97–x)BiScO₃–xPbTiO₃–0.03Pb(Mn_{1/3}Nb_{2/3})O₃ ceramics deteriorated severely ($d_{33} < 300$ pC N⁻¹).²⁴ The Curie temperature of 0.03Pb(Mn_{1/3}Sb_{2/3})O₃–0.33BS–0.64PT and

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BiScO₃–PbTiO₃–Pb(Yb_{1/2}Nb_{1/2})O₃ ceramics is less than 400 °C.^{23,26} Mn and Fe co-modified BS–PT ceramics show both a lower d_{33} of 235 pC N⁻¹ and dielectric constant ϵ_r of 815 compared with pure BS–PT ceramics.²⁵

GeO₂–glass former is an additive used in glass. This glass former can decrease the dielectric loss and increase insulativity. Ge⁴⁺ ions tend to segregate along the grain boundaries, leading to a reduction in the jumping of mobile ions, which in turn causes a decrease in the conductivity of the ceramics.²⁷ Mou *et al.* used Ge⁴⁺ to enhance the piezoelectric performance and adjusted dielectric properties.²⁸ GeO₂ can synchronously enhance the Q_m and piezoelectric properties in the KNN and BCZT system.^{29,30} Therefore, we investigated the effect of GeO₂ addition on the phase structure, dielectric, piezoelectric, ferroelectric and electromechanical coupling properties of BS–PT ceramics.

2. Experimental procedures

The GeO₂ doped 0.36BS–0.64PT piezoelectric ceramics (abbreviated as 0.36BS–0.64PT + x GeO₂, $x = 0$ mol%, 0.25 mol%, 0.5 mol%, 0.75 mol%, 1.0 mol%, 1.5 mol%) were prepared by the conventional solid-state reaction method. Starting materials were Bi₂O₃ (99.99%), Sb₂O₃ (99.99%), PbO (99.9%), TiO₂ (99.5%), and GeO₂ (99.99%). These oxide powders were weighed and mixed according to the chemical formula, adding 1 mol% Bi₂O₃ and PbO to compensate for evaporation during the sintering process. The mixture was ball milled for 12 h in absolute ethyl alcohol (99.7%) with zirconia balls, then dried and pressed into pellets at 60 MPa. The pellets were placed in a crucible and calcined at 780 °C for 5 h at a heating/cooling rate of 5 °C min⁻¹. Thereafter, the GeO₂ of different amounts was added to the calcined powder and ball milled again for another 24 h. After ball milling, the slurry was dried, crushed, and mixed with 5% polyvinyl alcohol binder (PVA). The powder was passed through a 200 mesh sieve and was pressed into pellets of 8 mm in diameter and 1.5 mm in thickness under an actual pressure of 200 MPa. Subsequently, it was heated at 600 °C for 2 h to eliminate the binder, and sintered in a sealed Al₂O₃ crucible in the range of 1000–1100 °C for 2 h to form ceramic samples.

The crystal structure of sintered ceramics was analyzed on an X-ray diffractometer (Rigaku, Miniflex600, Japan) with Cu–K α

radiation. The TEM was performed using a field emission transmission electron microscope (TEM, FEI Tecnai F20, USA). A scanning electron microscope (SEM, SU8010, Hitachi, Japan) was used to investigate the microstructure. The density of the sintered samples was determined by the Archimedes method. The obtained ceramics were polished to a thickness of 0.5 mm, and then coated with silver paste on the surface to form the electrodes. The samples were poled in an oil bath at 120 °C in an electric field of 40 kV cm⁻¹ for 15 min. After standing for 24 h, the electrical properties were tested. The dielectric constant (ϵ_r) and dielectric loss ($\tan \delta$) were measured on an impedance analyzer (E4990A, Agilent Technologies, USA), and the planar electromechanical coupling factor (k_p) and Q_m were calculated according to the resonance and anti-resonance method. Ferroelectric hysteresis loop measurements were performed on an aix-ACCT TF2000 ferroelectric analyzer ($f = 1$ Hz). Piezoelectric coefficients were measured by a quasi-static d_{33} meter (Institute of Acoustics, Chinese Academy of Sciences, model ZJ-4AN).

3. Results and discussion

3.1 Structure and phase analysis

Fig. 1(a) shows the X-ray diffraction patterns (log scale) of powder 0.36BS–0.64PT + x GeO₂ ceramics. The main peaks of all samples matched with the perovskite phase, indicating formed stable perovskite solid solutions. It can be easily seen that the second phase (GeO₂) appeared as the doping content of GeO₂ increased, indicating that it is difficult for Ge⁴⁺ to enter the lattice. The radius of Ge⁴⁺ ion (0.53 Å for CN = 6) is almost similar to that of Ti⁴⁺ ions (0.605 Å for CN = 6), and it is considered that Ge⁴⁺ ions can enter the B site of the perovskite unit cell and substitute Ti⁴⁺ ions.³¹ Fig. 1(b) shows the amplified images of (200)_c peaks. It can be easily seen that the phase structure is slightly changed after adding GeO₂. The lattice parameters of 0.36BS–0.64PT + x GeO₂ ceramics were calculated according to the diffraction patterns, as shown in Fig. 1(c). With the increase in the GeO₂ content, the “ c ” value decreases continuously while the “ a ” value increases, and the c/a value keeps decreasing from 1.023 to 1.014, which confirms that the Ge⁴⁺ ion entered the B site of the perovskite unit cell.

Fig. 2 shows the TEM image of 0.36BS–0.64PT + 0.5GeO₂ ceramics. One set of lattice fringes with an interplanar spacing

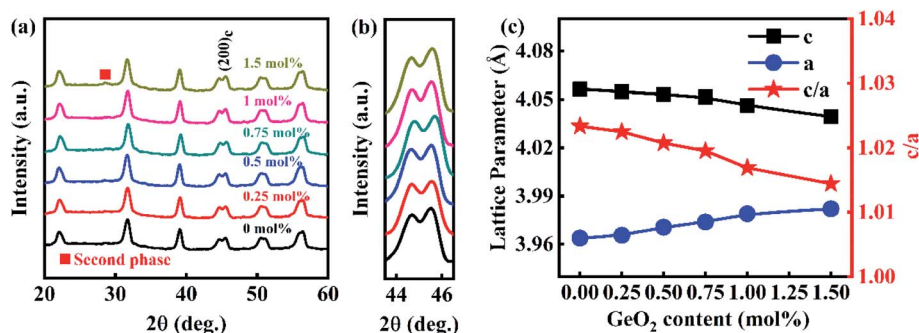


Fig. 1 (a) X-ray diffraction patterns (log scale) of powder 0.36BS–0.64PT + x GeO₂ ceramics. (b) The amplified images of (200)_c peaks. (c) Lattice parameters of 0.36BS–0.64PT + x GeO₂ ceramics.



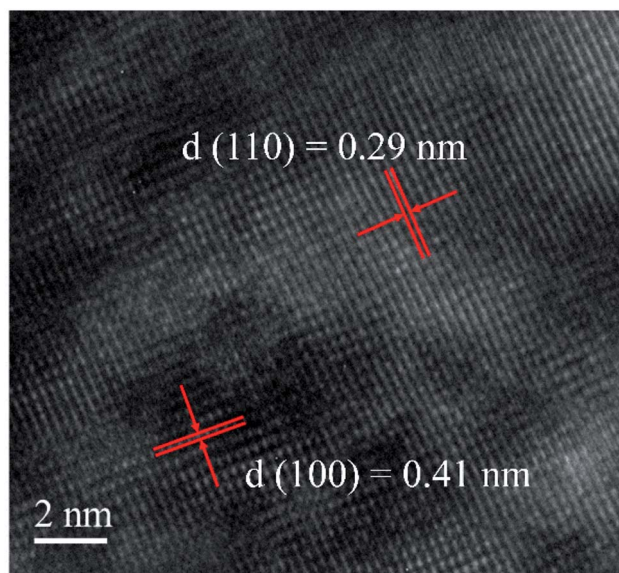


Fig. 2 TEM image of 0.36BS–0.64PT + 0.5GeO₂ ceramics.

of 0.29 nm, corresponding to the (110) plane of the perovskite phase, and another set of lattice fringes with a 0.41 nm interplanar spacing, corresponding to the (100) plane of the perovskite phase, which is consistent with the phase structure shown by the XRD results.

Fig. 3 shows the microstructure of 0.36BS–0.64PT + x GeO₂ ceramics sintered at 1080 °C for 2 h. These images clearly show the morphology of the ceramic samples with few holes, dense grains and clear grain boundaries. Table 1 lists the density of the 0.36BS–0.64PT + x GeO₂ ceramics. The actual density (ρ_1) was calculated by the Archimedes method, and the theoretical density (ρ_2) was calculated according to XRD data. The relative density (ρ_r) is 96.17–97.82%, showing a high density. The insets of Fig. 3 show the statistical data of the grain size of 0.36BS–0.64PT + x GeO₂ ceramics. With the increase in GeO₂, the average grain size decreases from 8.46 μ m to 2.54 μ m, indicating that GeO₂ can inhibit the growth of grains. A similar phenomenon has been reported in other Ge doped ceramics. Fig. 3(e and f) show that a small amount of GeO₂ gathers at the grain boundary, which hinders the movement of the grain

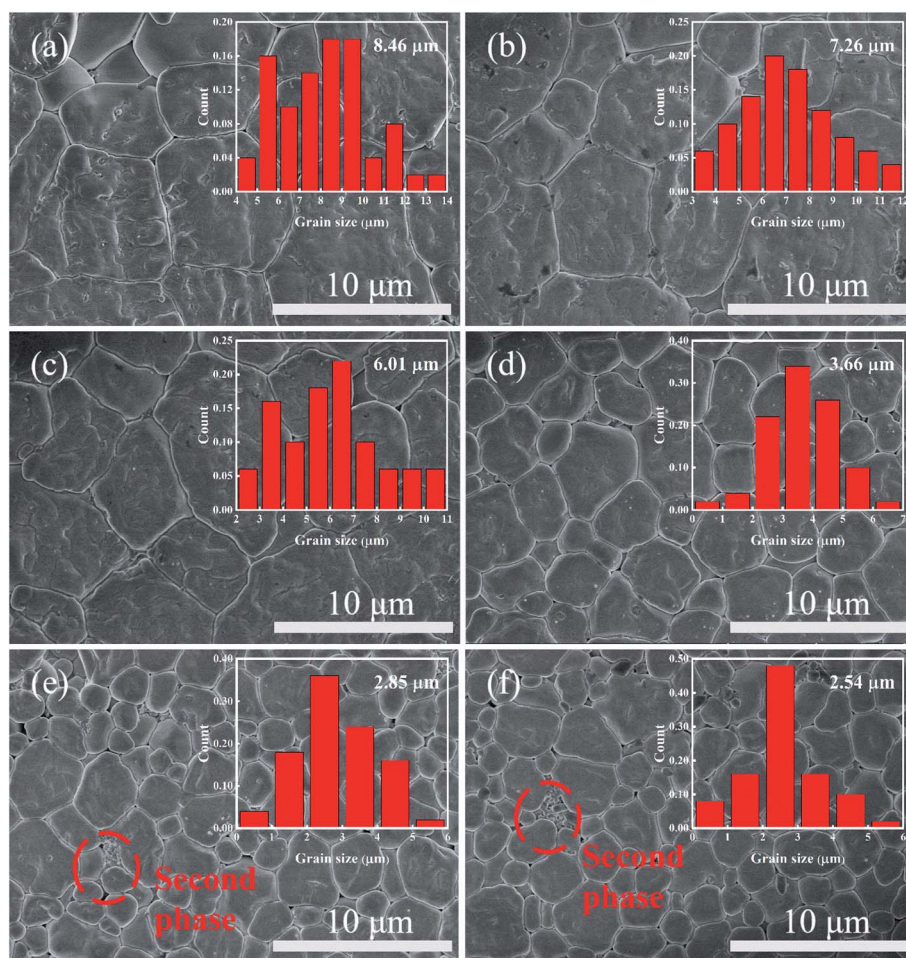


Fig. 3 SEM images of the surface of 0.36BS–0.64PT + x GeO₂ ceramics sintered at 1080 °C: (a) 0 mol% (b) 0.25 mol%, (c) 0.5 mol%, (d) 0.75 mol%, (e) 1.0 mol%, (f) 1.5 mol%. The insets show the statistical data of the grain size of 0.36BS–0.64PT + x GeO₂ ceramics.



Table 1 The variation in the density of 0.36BS–0.64PT + $x\text{GeO}_2$ ceramics (ρ_1 : actual density; ρ_2 : theoretical density; ρ_r : relative density)

x (mol%)	ρ_1 (g cm^{-3})	ρ_2 (g cm^{-3})	ρ_r (%)
0.00	7.53	7.83	96.17
0.25	7.58	7.82	96.93
0.50	7.64	7.81	97.82
0.75	7.61	7.80	97.56
1.00	7.58	7.79	97.30
1.50	7.52	7.79	96.53

boundary and restrains the grain growth. The results show that Ge^{4+} cannot be dissolved into the solid solution.

3.2 Dielectric properties

Fig. 4 shows the temperature dependence of ϵ_r and $\tan \delta$ of 0.36BS–0.64PT + $x\text{GeO}_2$ ceramics. The temperature of the maximum of dielectric constant (T_m) is considered as the Curie temperature (T_C).²³ Table 2 summarizes the ϵ_r , $\tan \delta$ and T_C of

0.36BS–0.64PT + $x\text{GeO}_2$ ceramics. The T_C of 0.36BS–0.64PT ceramics with 0, 0.25, 0.5, 0.75, 1 and 1.5 mol% GeO_2 are 449, 457, 455, 454, 458 and 462 °C, respectively, showing a small change of GeO_2 . The decrease in c/a indicates that the crystal structure shifts to the rhombohedral phase, and the Curie temperature should be reduced in theory. However, compared with the undoped BS–PT ceramic samples, the introduction of GeO_2 slightly increases the Curie temperature. It is indicated that the addition of GeO_2 is good for stabilizing the Curie temperature.

The values of ϵ_r at room temperature increased first and then decreased with the increase in GeO_2 , as shown in Table 2. The maximum ϵ_r observed when $x = 0.5$ mol% was 1280. An increase in the dielectric constant is related to an increase in density. The addition of GeO_2 to 0.36BS–0.64PT ceramics can improve the microstructure of the material. In addition, the GeO_2 doping is beneficial to reducing the dielectric loss.

It can be easily seen that all the samples exhibit a diffuse phase transition. The variation of the diffuse phase transition

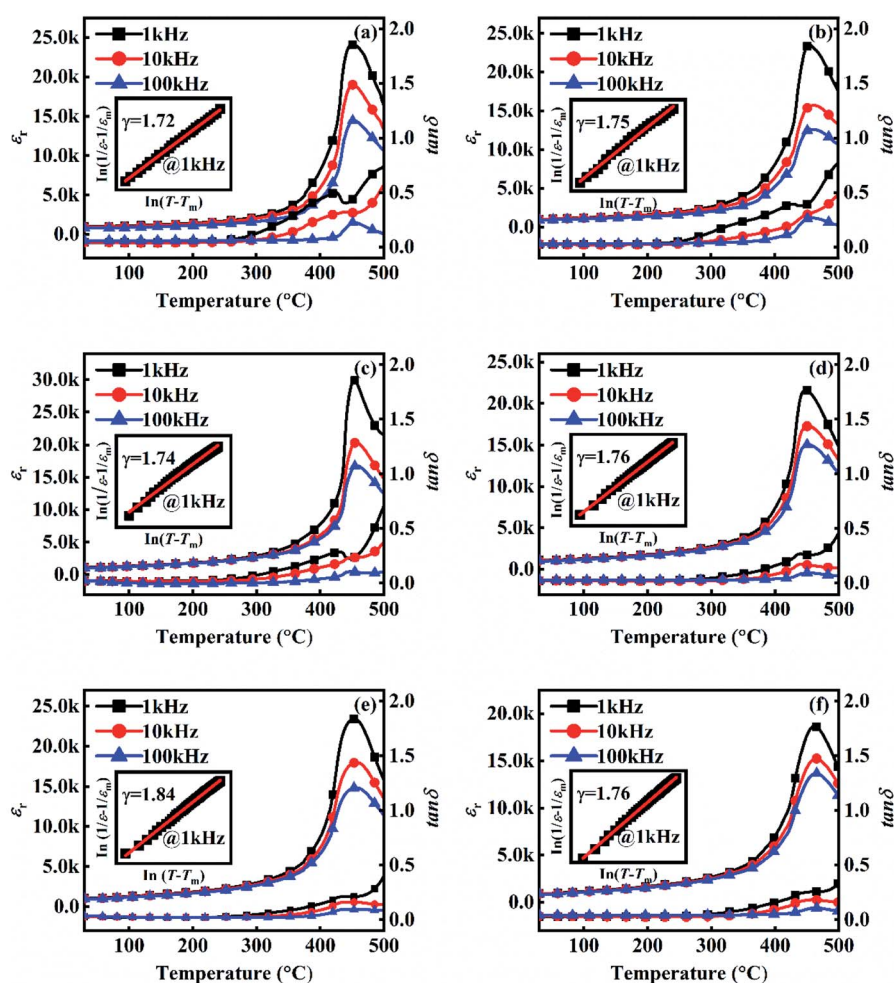
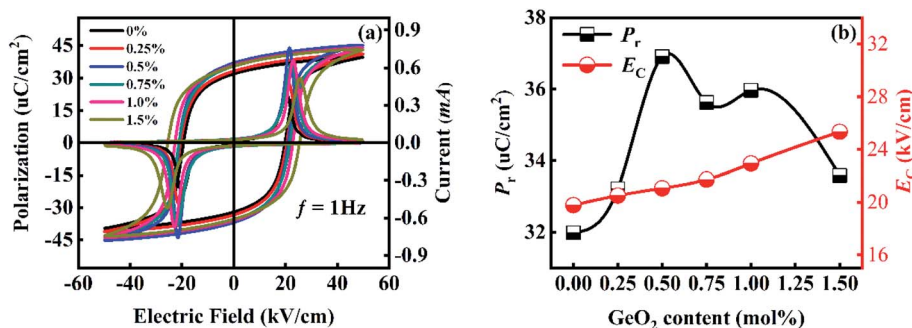


Fig. 4 Temperature dependence of ϵ_r and $\tan \delta$ of 0.36BS–0.64PT + $x\text{GeO}_2$ ceramics: (a) 0 mol% (b) 0.25 mol%, (c) 0.5 mol%, (d) 0.75 mol%, (e) 1.0 mol%, (f) 1.5 mol%. The insets show the fitting results using the semi-empirical Curie–Weiss law.



Table 2 Electrical properties of 0.36BS–0.64PT + xGeO₂ ceramics at room temperature

<i>x</i> (mol%)	<i>T_C</i> (°C)	ε _r (@1k Hz)	tan δ (%)	<i>E_C</i> (kV cm ⁻¹)	<i>P_r</i> (μC cm ⁻²)	<i>d</i> ₃₃ (pC N ⁻¹)	<i>k_p</i>	<i>Q_m</i>
0.00	449	1130	3.31	19	32	355	0.49	28
0.25	457	1150	1.47	20	33	370	0.53	75
0.50	455	1280	1.18	21	37	385	0.58	90
0.75	454	1240	1.44	22	36	335	0.55	101
1.00	458	1200	1.71	23	36	305	0.54	115
1.50	462	1070	1.97	25	35	270	0.52	132

Fig. 5 (a) *P*–*E* loops and *I*–*E* loops, (b) the variation of *P_r* and *E_C* of 0.36BS–0.64PT + xGeO₂ ceramics.

with increase in GeO₂ was explored. The diffuse phase transition can be described by the modified Curie–Weiss law:³²

$$\ln(1/\varepsilon - 1/\varepsilon_m) + \ln C = \gamma \ln(T - T_m) \quad (1)$$

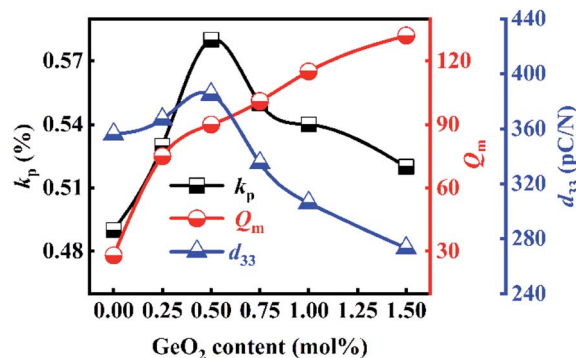
where *C* is the Curie Weiss constant, ε_m is the value of ε_r at *T_m*, and γ is the degree of phase transition diffuses. When γ is equal to 1, it is usually regarded as a normal ferroelectricity. For γ = 2, the relaxor ferroelectric completely diffuses the phase transition. Alternatively, the larger the γ value, the greater the degree of diffuse phase transition. The inset in Fig. 4 shows the fitting curve at 1 kHz of the 0.36BS–0.64PT + xGeO₂ ceramics, showing that the value of γ for all the ceramic samples is in the range of 1.72–1.84, indicating a strong relaxation behavior. The relaxor behavior is related to the heterogeneity of the solid solution. The complex ions occupy both the A-site (Bi, Pb) and B-site (Ti, Sc, Ga) in the perovskite structure, leading to a disordered distribution of ions.³³ Therefore, the value of γ reflects the degree of heterogeneity. The close values of γ indicate that the GeO₂ addition does not vary the degree of heterogeneity, which is consistent with the stability of the Curie temperature.

3.3 Ferroelectric and piezoelectric properties

Fig. 5(a) shows the *P*–*E* loops and *I*–*E* loops of 0.36BS–0.64PT + xGeO₂ ceramics measured at room temperature with 1 Hz. According to the *P*–*E* hysteresis loops, the variation of the values of remnant polarization (*P_r*) and coercive field (*E_C*) was obtained, as shown in Fig. 5(b) and Table 2. The *P_r* value of the virgin BS–PT ceramics is 32 μC cm⁻². The *P_r* values increase significantly when a small amount of GeO₂ is added. 0.36BS–0.64PT + 0.5 mol%GeO₂ ceramics have the maximum *P_r* value (37 μC

cm⁻²). When the GeO₂ added is higher than 0.50 mol%, the value of *P_r* decreases slightly because of the glass phase formed by the addition of GeO₂. The value of *E_C* gradually increases as the GeO₂ content increases, indicating the enhanced breakdown strength.

Fig. 6 shows the variation trend of piezoelectric coefficient (*d*₃₃), planar electromechanical coupling factor (*k_p*), and mechanical quality factor (*Q_m*) of the 0.36BS–0.64PT + xGeO₂ ceramics. The detailed data of *d*₃₃, *k_p*, *Q_m* are listed in Table 2. As shown in Fig. 6, the *d*₃₃ and *k_p* of 0.36BS–0.64PT + xGeO₂ ceramics increased first and then decreased. The maximum value of *d*₃₃ and *k_p* is 385 pC N⁻¹, 58% at *x* = 0.50 mol%, which is higher than that of the virgin BS–PT ceramics (355 pC N⁻¹, 49%). The enhanced piezoelectric performance is attributed to the combined effect of the grain size. The piezoelectric

Fig. 6 The variation of *k_p*, *Q_m* and *d*₃₃ of 0.36BS–0.64PT + xGeO₂ ceramics.

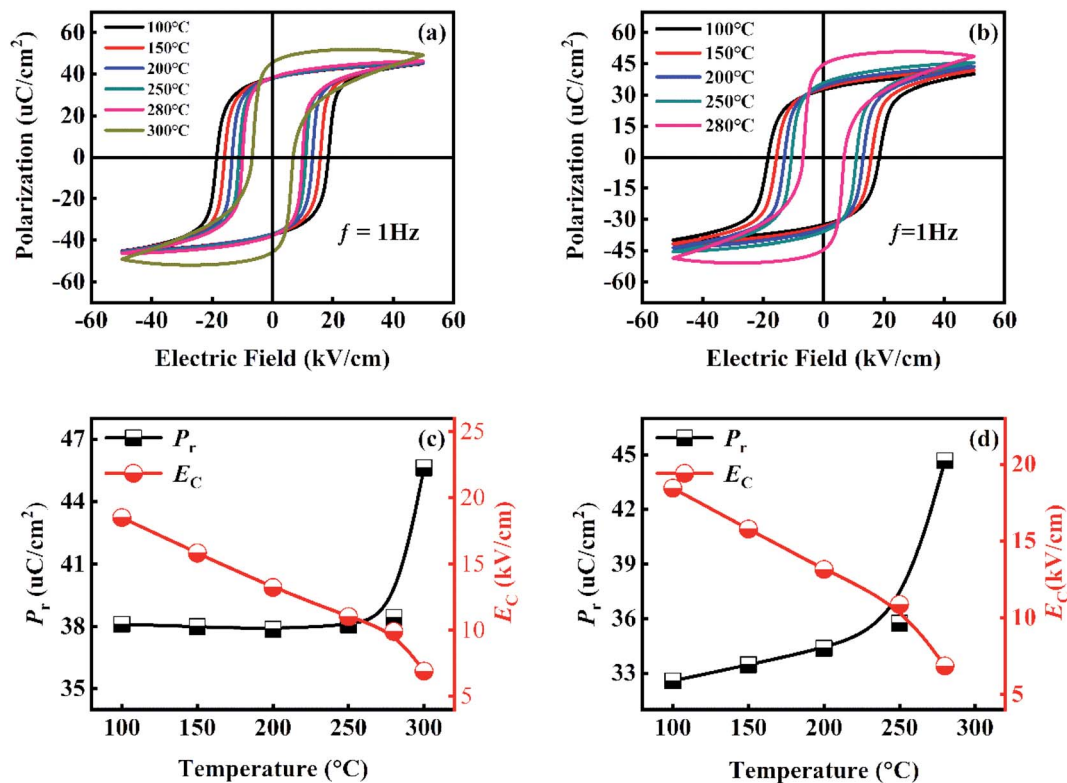


Fig. 7 Temperature dependence of (a and b) P - E loops, and (c and d) P_r and E_c for (a and c) $0.36\text{BS}-0.64\text{PT} + 0.5 \text{ mol}\% \text{GeO}_2$ and (b and d) $0.36\text{BS}-0.64\text{PT}$ ceramics.

performance decreased as the GeO_2 content increased beyond 0.50 mol%. The addition of GeO_2 can obstruct the movement of the domain and reduce the external contribution to piezoelectricity, resulting in a decrease in d_{33} .²⁹ Interestingly, the Q_m value of ceramic increased monotonically with the increase in the GeO_2 concentration. It is concluded that the addition of GeO_2 can improve the mechanical quality factor, which is consistent with the variation of E_c .

3.4 Thermal stability

Thermal stability is valuable for sensors and actuators in various industrial applications. Fig. 7 shows the temperature dependence of P - E loops of the $0.36\text{BS}-0.64\text{PT} + 0.5 \text{ mol}\% \text{GeO}_2$ and $0.36\text{BS}-0.64\text{PT}$. All curves were measured under an electric field of 50 kV cm^{-1} with a frequency of 1 Hz. As the temperature increased, the P - E loops of $0.36\text{BS}-0.64\text{PT} + 0.5 \text{ mol}\% \text{GeO}_2$ ceramics still maintained a good rectangular loop at 280°C without obvious leakage conductance. When the temperature rose to 300°C , the leakage current was too large to form a saturated P - E loop confirmed by the abnormal high value of P_r (see Fig. 7(a)). The variation of the P_r and E_c of $0.36\text{BS}-0.64\text{PT} + 0.5 \text{ mol}\% \text{GeO}_2$ ceramics are shown in Fig. 7(c). The E_c decreased from 19 kV cm^{-1} at 100°C to 10 kV cm^{-1} at 280°C , while the P_r remained almost unchanged. The clear leakage conductance appears at 280°C for $0.36\text{BS}-0.64\text{PT}$ ceramics, as shown in Fig. 7(b and d), which is consistent with literature that BS-PT ceramics begin to degrade at 250°C .³⁴ The temperature stability

of piezoelectric devices based on BS-PT ceramics is only 250°C .^{35,36} Therefore, it is indicated that the addition of GeO_2 is in favor of the enhancement of the thermal stability of BS-PT ceramics.

To further characterize the temperature stability of the samples, the poling samples were annealed at different temperatures for one hour, and their d_{33} was measured again at room temperature (Fig. 8). It can be easily seen that the d_{33} of $0.36\text{BS}-0.64\text{PT}$ ceramics starts decreasing above 250°C .

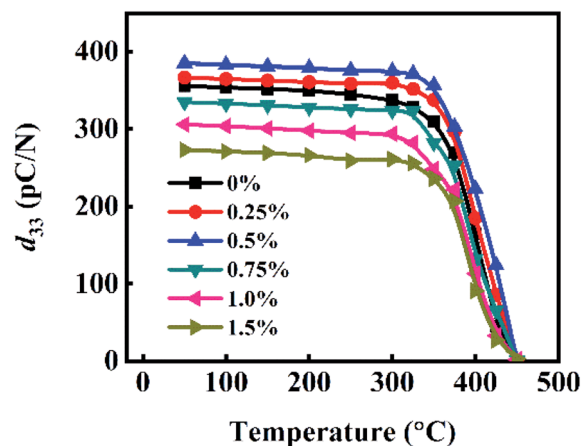


Fig. 8 The thermal stability of d_{33} of $0.36\text{BS}-0.64\text{PT} + x\text{GeO}_2$ ceramics.



Compared with 0.36BS–0.64PT ceramics, the 0.36BS–0.64PT + 0.5 mol%GeO₂ ceramics exhibit unchanged d_{33} above 300 °C. This indicates that GeO₂ addition improves the piezoelectric performance of BS–PT ceramics.

4. Conclusions

The phase structure, microstructure, dielectric, ferroelectric, and piezoelectric properties of 0.36BS–0.64PT + xGeO₂ ceramics were presented. A small amount of GeO₂ can decrease the grain size. With the increase in the GeO₂ content, the values of ϵ_r , d_{33} , k_p increased first and then decreased, while the values of E_C , Q_m increased monotonically. Interestingly, the Curie temperature of 0.36BS–0.64PT + xGeO₂ ceramics changes only slightly with different contents of GeO₂. The optimal composition is 0.36BS–0.64PT + 0.5 mol%GeO₂ ceramics with T_C of 455 °C, d_{33} of 385 pC N⁻¹, k_p of 58%, Q_m of 90. Compared with 0.36BS–0.64PT ceramics, the enhanced Q_m and stability of 0.36BS–0.64PT + 0.5 mol%GeO₂ ceramics is due to the addition of GeO₂. This study provides a paradigm for improving the mechanical quality factor of BS–PT-based ceramics.

Conflicts of interest

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

Acknowledgements

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